Lower Total Cost of Ownership (TCO)

NuvoGo™ 1000XL ensures reduced total cost of ownership while meeting the industry’s increasing demands for high-end mass production. With lower service cost per print, the system offers manufacturers a significantly lower TCO to quickly achieve maximum ROI. Setting a new industry standard, the system provides efficient power consumption while still providing a powerful light source and the most sophisticated optical and electronic systems. NuvoGo™ 1000XL supports a variety of resist types enabling manufacturers to select lower cost resists to further reduce operational costs.

Specifications

<table>
<thead>
<tr>
<th>Specification</th>
<th>Value</th>
</tr>
</thead>
<tbody>
<tr>
<td>Min. SRO</td>
<td>75μm</td>
</tr>
<tr>
<td>Min. Dam Size</td>
<td>50μm</td>
</tr>
<tr>
<td>Imaging Energy Range</td>
<td>25 - 2,200</td>
</tr>
<tr>
<td>Registration Accuracy F1S**</td>
<td>±10μm</td>
</tr>
<tr>
<td>Side-to-Side Registration F1B**</td>
<td>20μm</td>
</tr>
<tr>
<td>Max. Substrate Size</td>
<td>660mm x 812mm</td>
</tr>
<tr>
<td>Max. Exposure Area</td>
<td>635mm x 812mm</td>
</tr>
<tr>
<td>Substrate Thickness***</td>
<td>0.025mm - 8mm</td>
</tr>
<tr>
<td>Depth-of-Focus</td>
<td>±300μm</td>
</tr>
</tbody>
</table>

Applications

- Flex Solder Mask
- Inner layers and outer layers (especially high energy resists)
- Sequential build-up layers
- Hole-free inner layer registration
- Stamping (serialization, scale factor, date / time)
- 2D barcode stamp
- Wise Scaling
- Partial Scaling
- Group Scaling and stamping
- Additional vacuum customization plate
- Automation options:
  - DLU - DL Loading Unit
  - Flipper
  - Loader & unloader
- Specifications are subject to change without notice.

system Options

NuvoGo™ 1000XL for Patterning

<table>
<thead>
<tr>
<th>Specification</th>
<th>Value</th>
</tr>
</thead>
<tbody>
<tr>
<td>Throughput* [prints/h]</td>
<td>290</td>
</tr>
<tr>
<td>Min. Feature Size*</td>
<td>24μm</td>
</tr>
<tr>
<td>Address Resolution</td>
<td>2.0μm</td>
</tr>
</tbody>
</table>

* Depends on resolution and photoresist properties
** All values are ±5 full format
*** Including DFR or solder resist thickness
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www.orbotech.com/pcb
NUVGO™ 1000XL

The New Way of Imaging

Nuvogo™ 1000XL is the large format of the latest addition to Orbotech’s Nuvogo™ family of leading Direct Imaging (DI) solutions. Utilizing a high power laser and unique MultiWave Laser Technology™, the Nuvogo™ 1000XL provides maximum flexibility on a wide range of materials and applications. Incorporating Orbotech’s field-proven Large Scan Optics (LSO) Technology™ with its high depth-of-focus, it is a perfect match for Flex Solder Mask applications that demand fine structures on changing topography. This powerful system is designed for fast throughput while maintaining optimal quality.

**Benefits**

**Leading Mass Production Digital Imaging**
- In-line solution and fully-integrated automation for seamless production
- Optimized imaging time with dual table transport mechanism
- Fast and easy setup; operator friendly
- Clean, handling-free production environment

**MultiWave Laser Technology™ for Maximum Resist Flexibility**
- Embedded MultiWave Laser Technology™ ensures small undercut and excellent side walls
- Addresses a wide range of materials and applications

**Highest Imaging Quality with LSO Technology™**
- Unique optics design for optimal line-structure and solder dam uniformity
- High depth-of-focus up to ±300μm for unmatched quality on changing surface topographies (especially for Solder Mask Flex applications)
- Advanced scaling modes for superior registration accuracy down to ±10μm

**Lower Total Cost of Ownership (TCO)**
- Optimized service cost per print
- Increased overall efficiency for significant long-term savings
- Suited for a wide variety of resists, offering the option to use lower-cost materials

**Nuvo” 1000XL for State-of-the-Art Mass Production Digital Imaging**

As part of the Nuvogo™ family, the Nuvogo™ 1000XL utilizes Orbotech’s high power MultiWave Laser Technology™. Equipped with the industry’s most advanced optics and electronics, Nuvogo™ 1000XL is designed to achieve fine structures at unmatched speeds. Its dual table transport mechanism achieves maximum use of system time for panel imaging. Furthermore, the system’s fast setup capabilities and automatic acquisition of targets facilitate smooth job changes. Nuvogo™ 1000XL also operates in a clean, hands-free environment, thus ensuring no handling damage.

**Orbotech High Power MultiWave Laser Technology™ for Maximum Resist Flexibility**

Nuvogo™ 1000XL is powered by Orbotech’s high power MultiWave Laser Technology™ which delivers unparalleled structure quality on a variety of resists and solder resists. It also provides maximum flexibility to match any solder resist and to fit all forms and processes. The adaptable multi-wavelength laser also minimizes undercut to allow extremely smooth side walls.

**Highest Imaging Quality With LSO Technology™**

**Registration Accuracy**
Registration accuracy down to ±10μm, enabling tight Solder Mask clearances.

**Innovative Scaling Modes**
- Auto Scaling / Fixed Scaling / Group Scaling
- Partial Scaling – sub-area registration for Solder Mask exposure

**Depth-of-Focus (D.o.F.)**
- D.o.F up to ±300μm for overcoming the most challenging surface topography changes and any distortion or abnormalities with the most advanced image quality
- Single scan allows uniform imaging of the entire panel

**Resolution and Line Uniformity**
- Best line uniformity (down to 24μm in patterning)
- Allows solder dams down to 50μm and SRO down to 75μm

**Ease-of-Use**
- Operator-friendly, intuitive graphical user interface
- Seamless connectivity to CAM ensures fast and easy set-up
- Recognizes a wide array of different target types to meet any production demands
- Supports side-by-side Flex imaging

**Traceability**
Enables panel tracking by marking: serial number stamp; sub-panel and PCB; date and time stamp; scaling stamp and machine ID by alphanumeric stamping or 1-D barcode / 2-D barcode (Data Matrix Code).
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